NSN 5962-01-157-6004

Memory Microcircuit - Page 1 of 1



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Body Length: 2.060 inches **Body Width:** Between 0.530 inches and 0.550 inches **Body Height:** 0.175 inches **Maximum Power Dissipation Rating:** 1.0 watts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+150.0 degrees celsius **Features Provided:** Hermetically sealed and bidirectional and static operation and w/enable and w/reset **Inclosure Material:** Ceramic **Inclosure Configuration:** Dual-in-line **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Input Circuit Pattern:** 37 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 5.3 volts power source **Time Rating Per Chacteristic:** 250.00 nanoseconds propagation delay time, low to high level output and 250.00 nanoseconds propagation delay time, high to low level output Memory Device Type: Ram **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 40 printed circuit Shelf Life: N/a Unit Of Measure:

Demilitarization:

Yes - demil/mli

Fiig:

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